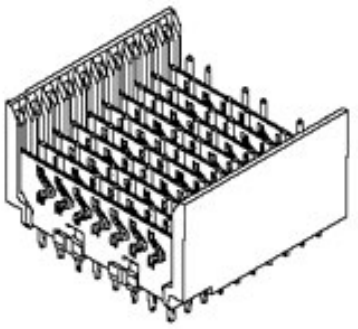
This document was generated on 05/27/2010

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: 0746491004
Status: Active
Overview: vhdm__hsd
Description: 2.00mm (.079") Pitch 8-Row VHDM-HSD™ Backplane Header, Open Module, 80 Circuits, Pin Length 5.15mm (.203")



Series image - Reference only

Documents:
Drawing (PDF)
RoHS Certificate of Compliance (PDF)

Agency Certification

CSA	LR19980
UL	E29179

General

Product Family	Backplane Connectors
Series	74649
Application	Backplane
Application Tooling Documents	Tooling Manual
Comments	Open Header
Component Type	PCB Header
Overview	vhdm__hsd
Product Name	VHDM-HSD™
Style	N/A

Physical

Circuits (Loaded)	80
Circuits (maximum)	80
Color - Resin	Black
Durability (mating cycles max)	200
First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Copper-Nickel-Silicon, High Performance Alloy (HPA)
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Number of Columns	10
Number of Pairs	Open Pin Field
Number of Rows	8
Orientation	Vertical
PC Tail Length (in)	0.098 In
PC Tail Length (mm)	2.50 mm
PCB Locator	No
PCB Retention	None
PCB Thickness Recommended (in)	0.070 In
PCB Thickness Recommended (mm)	1.80 mm
Packaging Type	Tube
Pitch - Mating Interface (in)	0.079 In
Pitch - Mating Interface (mm)	2.00 mm
Pitch - Term. Interface (in)	0.079 In
Pitch - Term. Interface (mm)	2.00 mm
Plating min: Mating (µin)	30
Plating min: Mating (µm)	0.75
Plating min: Termination (µin)	30

EU RoHS
RoHS Compliant by Exemption
REACH SVHC
Contains SVHC: No
Halogen-Free Status
Halogen-Free

China RoHS
50
Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of Compliance, click here

Please visit the Contact Us section for any non-product compliance questions.

Search Parts in this Series
74649Series

Mates With
HSD Daughtercards 74680 , 74686

Use With
Daughtercard Modules

Application Tooling | **FAQ**
Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
VHDM® Insertion Module for Advanced Mate Signal Header, 8 Row by 10 Wide, 20.00mm (.787")	0622020205

Plating min: Termination (µm)	0.75
Polarized to PCB	Yes
Stackable	Yes
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

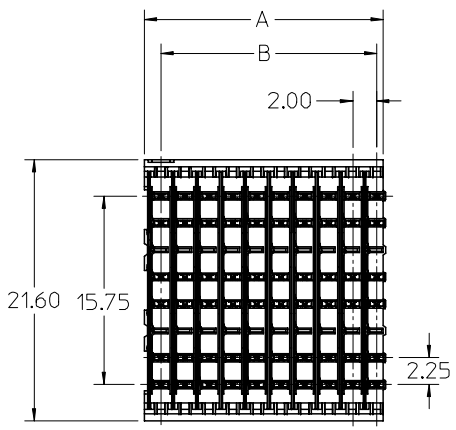
Current - Maximum per Contact	1A
Data Rate	5.0 Gbps
Real Signals (per 25mm)	72
Shield Type	Ground Plane Shield
Shielded	Yes
Voltage - Maximum	250V

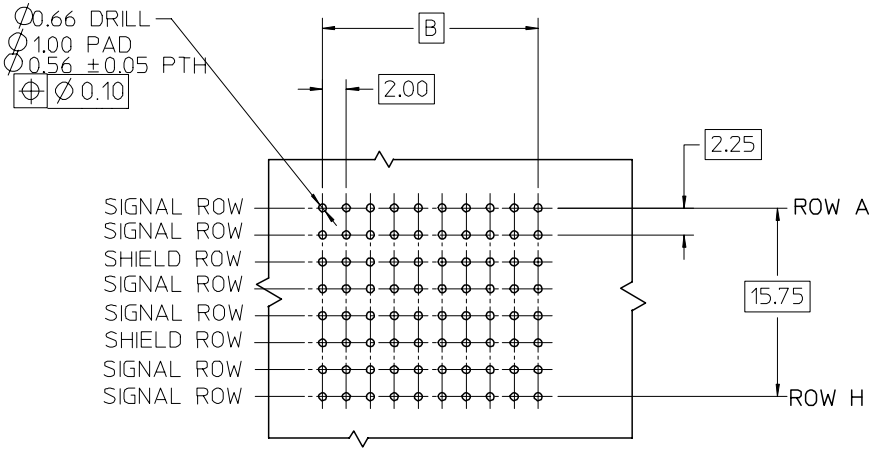
Material Info

Reference - Drawing Numbers

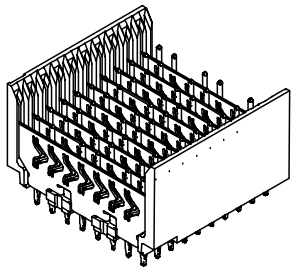
Packaging Specification	PK-74060-003
Sales Drawing	SD-74649-002

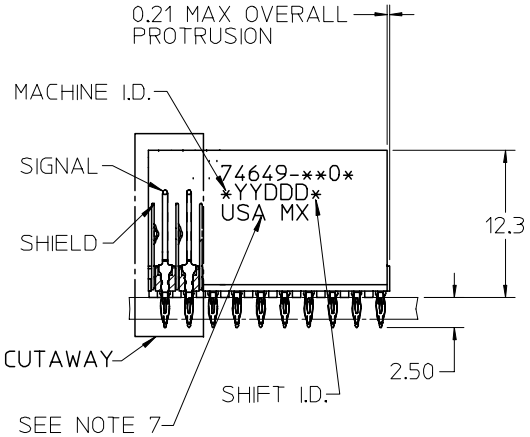
VHDM-HSD is a trademark of Amphenol Corporation

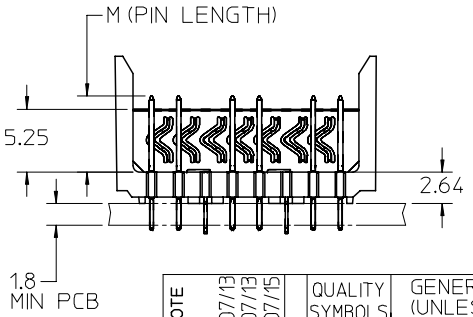




BACKPLANE HOLE PATTERN
RECOMMENDED DIMENSION







NOTES:

1. MATERIAL:
   HOUSING -LIQUID CRYSTAL POLYMER (LCP), GLASS-FILLED, UL 94V-0, COLOR BLACK.
   SIGNAL PIN & SHIELD -HIGH PERFORMANCE COPPER ALLOY.
2. FINISHES:
   CONTACT AREA: SELECTIVE GOLD (Au)
   PCB TAILS: SELECTIVE TIN/LEAD (Sn/Pb) OR SELECTIVE MATTE TIN (Sn)
   NICKEL (Ni) OVERALL.
3. THIS PART CONFORMS TO MOLEX PRODUCT SPECIFICATION PS-74031-999.
4. FOR MIXED CONTACT MATING LENGTHS CONSULT MOLEX FOR AVAILABILITY.
5. FOR SPECIFIC PART NUMBERS AND MATING INFORMATION REFER TO SHEET 2.
6. PACKAGE PER PK-74060-003.
7. EITHER MARK PART NUMBER AND DATE CODE APPROXIMATELY WHERE SHOWN OR PLACE LABEL ON THE TUBE.

REVISED - PLATING NOTE
EC NO: UCP2006-0051 2005/07/13
DRWN: KMULVEY 2005/07/13
CH'KD:
APPR: SREED 2005/07/15
DESCRIPTION
REV
D

QUALITY SYMBOLS
▼ = 0
▽C = 0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

SCALE	2.5:1
DESIGN UNITS	METRIC
DIMENSION STYLE	MM ONLY
DRAWN BY	MQWANG
DATE	2001/01/22
CHECKED BY	JLAURX
DATE	2001/01/23
APPROVED BY	CBIXLER
DATE	2001/01/24

THIRD ANGLE PROJECTION
REVISE ON CAD ONLY

TITLE
HSD SALES ASSEMBLY
8 ROW OPEN END
BACKPLANE

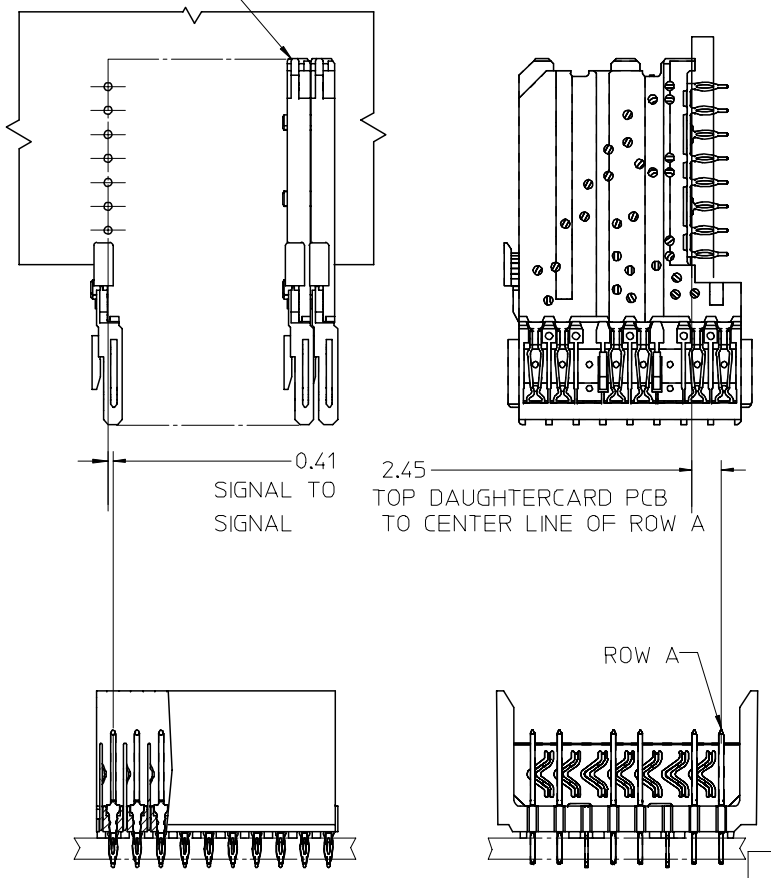
MOLEX INCORPORATED

MATERIAL NO.	DOCUMENT NO.	SHEET NO.
SEE SHEET 2	SD-74649-002	1 OF 2

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION

B

DAUGHTERCARD
CONNECTOR SIDE



MATERIAL NUMBER ASSIGNMENT

74649-XXYY

SEE TABLE

10 = 10 COLUMN TIN/LEAD
25 = 25 COLUMN TIN/LEAD
90 = 10 COLUMN MATTE TIN
85 = 25 COLUMN MATTE TIN

PART NUMBER	COLUMN	NUMBER OF SIGNAL PINS	NUMBER OF SHIELDS	A	B	M	Au (um) MIN THICKNESS	Sn (um) THICKNESS
74649-*001	10	60	10	20.00	18.00	4.75	0.76	0.76-1.52
74649-*006							1.27	
74649-*501	25	150	25	50.00	48.00		0.76	
74649-*506							1.27	
74649-*002	10	60	10	20.00	18.00	6.25	0.76	
74649-*007							1.27	
74649-*502	25	150	25	50.00	48.00		0.76	
74649-*507							1.27	
74649-*003	10	60	10	20.00	18.00	4.25	0.76	
74649-*008							1.27	
74649-*503	25	150	25	50.00	48.00		0.76	
74649-*508							1.27	
74649-*004	10	60	10	20.00	18.00	5.15	0.76	
74649-*009							1.27	
74649-*504	25	150	25	50.00	48.00		0.76	
74649-*509							1.27	

SEE SHEET 1
EC NO: UCP2006-0051
DRWN:KMULVEY 2005/07/13
CH'KD: 2005/07/13
APPR: SREED 2005/07/15
DESCRIPTION
REV
D

QUALITY SYMBOLS
▼ = 0
Ⓒ = 0

GENERAL TOLERANCES (UNLESS SPECIFIED)

	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ±1/2°		

DRAFT WHERE APPLICABLE
MUST REMAIN
WITHIN DIMENSIONS

SCALE 2.5:1
DESIGN UNITS METRIC
THIRD ANGLE PROJECTION
REVISE ON CAD ONLY
DIMENSION STYLE MM ONLY
DRAWN BY MQWANG DATE 2001/01/22
CHECKED BY JLAURX DATE 2001/01/23
APPROVED BY CBIXLER DATE 2001/01/24

TITLE
HSD SALES ASSEMBLY
8 ROW OPEN END
BACKPLANE

MOLEX INCORPORATED

MATERIAL NO. SEE TABLE
DOCUMENT NO. SD-74649-002
SHEET NO. 2 OF 2

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B

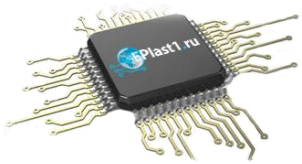
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.